



Customer Information Notification

2016110071

Issue Date: 17-Nov-2016
Effective Date: 01-Feb-2017

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

Management Summary

Added additional min/max specs for some parameters for BGU8009.

Change Category

<input type="checkbox"/> Wafer Fab Process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Test Location	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab Materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Process	<input type="checkbox"/> Errata
<input type="checkbox"/> Wafer Fab Location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Equipment	<input checked="" type="checkbox"/> Electrical spec./Test coverage

BGU8009: updated data sheet

Information Notification

Added additional min/max specs for the following parameters:

- Icc
- Gp
- NF
- Pi(1dB)
- IP3i

The data sheets can be found on: www.nxp.com or attached into PQP.

Why do we issue this Information Notification

Added additional min/max specs for some parameters.

Identification of Affected Products

NA

Impact

no impact to the product's functionality anticipated.
No change in form, fit and function.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

NA

Additional information

Affected products and sales history information: see attached file

Remarks

No change in form, fit and function. Datasheet already published on the internet.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Wali Ahmad
Position Sr. Customer Quality Engineer
e-mail address wali.ahmad@nxp.com

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Outline	Package Name	Status	Product Line
BGU8009,115	934066566115	BGU8009	MMIC	SOT1230	XSON6	RFS	BL Smart Antenna Solutions